

**FLAME RETARDANT MOLDING COMPOSITIONS  
CONTAINING GROUP IVA METAL OXIDES**

**ABSTRACT OF THE DISCLOSURE**

**[0046]** A molding composition that is particularly useful for coating and encapsulating electronic or electrical devices is disclosed. The molding composition exhibits improved flame retardancy and includes an epoxy resin, a hardener for the epoxy resin, and flame retardant compounds of melamine cyanurate and an oxyanion of a Group VIA element, such as tungsten trioxide.